Burr-Brown Products from Texas Instruments

## Resolutiongecess 24-Bit, 40 kHz ANALOG-TO-DIGITAL CONVERTER

## FEATURES

- 24 BITS—NO MISSING CODES
- 19 BITS EFFECTIVE RESOLUTION UP TO 40kHz DATA RATE
- LOW NOISE: 2.5ppm
- DIFFERENTIAL INPUTS
- INL: 0.0015\% (max)
- EXTERNAL REFERENCE (0.5V to 5V)
- POWER-DOWN MODE
- SYNC MODE


## APPLICATIONS

- CARDIAC DIAGNOSTICS
- DIRECT THERMOCOUPLE INTERFACES
- BLOOD ANALYSIS
- INFRARED PYROMETERS
- LIQUID/GAS CHROMATOGRAPHY
- PRECISION PROCESS CONTROL


## DESCRIPTION

The ADS1252 is a precision, wide dynamic range, delta-sigma, Analog-to-Digital (A/D) converter with 24 -bit resolution operating from a single +5 V supply. The delta-sigma architecture is used for wide dynamic range and to guarantee 24 bits of no missing codes performance. An effective resolution of 19 bits ( 2.5 ppm of rms noise) is achieved for conversion rates up to 40 kHz .
The ADS1252 is designed for high-resolution measurement applications in cardiac diagnostics, smart transmitters, industrial process control, weight scales, chromatography, and portable instrumentation. The converter includes a flexible, two-wire synchronous serial interface for low-cost isolation.
The ADS1252 is a single-channel converter and is offered in an SO-8 package.


## SPECIFICATIONS

All specifications at $T_{\text {MIN }}$ to $T_{M A X}, V_{D D}=+5 \mathrm{~V}, C L K=16 \mathrm{MHz}$, and $\mathrm{V}_{\text {REF }}=4.096$, unless otherwise specified.

\begin{tabular}{|c|c|c|c|c|c|}
\hline \multirow[b]{2}{*}{PARAMETER} \& \multirow[b]{2}{*}{CONDITIONS} \& \multicolumn{3}{|c|}{ADS1252U} \& \multirow[b]{2}{*}{UNITS} \\
\hline \& \& MIN \& TYP \& MAX \& \\
\hline \begin{tabular}{l}
ANALOG INPUT Input Voltage Range Input Impedance \\
Input Capacitance Input Leakage
\end{tabular} \& \[
\begin{gathered}
\mathrm{CLK}=3,840 \mathrm{~Hz} \\
\mathrm{CLK}=1 \mathrm{MHz} \\
\mathrm{CLK}=16 \mathrm{MHz} \\
\text { At }+25^{\circ} \mathrm{C} \\
\text { At } \mathrm{T}_{\text {MIN }} \text { to } \mathrm{T}_{\text {MAX }}
\end{gathered}
\] \& 0 \& \[
\begin{gathered}
79 \\
300 \\
19 \\
20 \\
5
\end{gathered}
\] \& \begin{tabular}{l}
\[
\pm \mathrm{V}_{\mathrm{REF}}
\] \\
50 \\
1
\end{tabular} \& \begin{tabular}{l}
V \\
\(\mathrm{M} \Omega\) \\
k \(\Omega\) \\
\(k \Omega\) \\
pF \\
pA \\
nA
\end{tabular} \\
\hline \begin{tabular}{l}
DYNAMIC CHARACTERISTICS \\
Data Rate \\
Bandwidth \\
Serial Clock (SCLK) \\
System Clock Input (CLK)
\end{tabular} \& -3dB \& 9 \& \& \[
\begin{gathered}
41.7 \\
16 \\
16
\end{gathered}
\] \& \begin{tabular}{l}
kHz \\
kHz \\
MHz \\
MHz
\end{tabular} \\
\hline \begin{tabular}{l}
ACCURACY \\
Integral Non-Linearity \({ }^{(1)}\) \\
THD \\
Noise \\
Resolution \\
No Missing Codes \\
Common-Mode Rejection \({ }^{(2)}\) \\
Gain Error \\
Offset Error \\
Gain Sensitivity to \(\mathrm{V}_{\text {REF }}\) \\
Power-Supply Rejection Ratio
\end{tabular} \& \begin{tabular}{l}
1kHz Input; 0.1 dB below FS \\
at DC
\[
V_{\text {REF }}=4.096 \mathrm{~V} \pm 0.1 \mathrm{~V}
\]
\end{tabular} \& \begin{tabular}{l}
24 \\
24 \\
90 \\
60
\end{tabular} \& \(\pm 0.0003\)
97
2.5

100
0.4
$\pm 100$
$1: 1$

80 \& $$
\begin{gathered}
\pm 0.0015 \\
3.8 \\
\\
\\
1 \\
\pm 200
\end{gathered}
$$ \& ```

    % of FSR
        dB
    ppm of FSR, rms
Bits
Bits
dB
% of FSR
ppm of FSR

```
        dB \\
\hline \begin{tabular}{l}
PERFORMANCE OVER TEMPERATURE \\
Offset Drift \\
Gain Drift
\end{tabular} & \[
\begin{aligned}
& \mathrm{CLK}=16 \mathrm{MHz} \\
& \mathrm{CLK}=14 \mathrm{MHz} \\
& \mathrm{CLK}=12 \mathrm{MHz} \\
& \mathrm{CLK}<10 \mathrm{MHz}
\end{aligned}
\] & & \[
\begin{gathered}
0.07 \\
7.5 \\
5.2 \\
3.9 \\
3.4
\end{gathered}
\] & & \begin{tabular}{l}
\(\mathrm{ppm} /{ }^{\circ} \mathrm{C}\) \\
\(\mathrm{ppm} /{ }^{\circ} \mathrm{C}\) \\
\(\mathrm{ppm} /{ }^{\circ} \mathrm{C}\) \\
\(\mathrm{ppm} /{ }^{\circ} \mathrm{C}\) \\
\(\mathrm{ppm} /{ }^{\circ} \mathrm{C}\)
\end{tabular} \\
\hline \begin{tabular}{l}
VOLTAGE REFERENCE \\
\(V_{\text {REF }}\) \\
Load Current
\end{tabular} & & 0.5 & \[
\begin{gathered}
4.096 \\
220
\end{gathered}
\] & \(V_{D D}\) & \[
\begin{gathered}
\mathrm{V} \\
\mu \mathrm{~A}
\end{gathered}
\] \\
\hline \begin{tabular}{l}
DIGITAL INPUT/OUTPUT \\
Logic Family \\
Logic Level: \(\mathrm{V}_{\mathrm{IH}}\) \\
\(\mathrm{V}_{\mathrm{IL}}\) \\
\(\mathrm{V}_{\mathrm{OH}}\) \\
\(V_{\mathrm{OL}}\) \\
Input (SCLK, CLK) Hysteresis \\
Data Format
\end{tabular} & \[
\begin{aligned}
& \mathrm{I}_{\mathrm{OH}}=-500 \mu \mathrm{~A} \\
& \mathrm{I}_{\mathrm{OL}}=500 \mu \mathrm{~A}
\end{aligned}
\] & \[
\begin{aligned}
& +4.0 \\
& -0.3 \\
& +4.5
\end{aligned}
\] & \begin{tabular}{l}
CMOS \\
0.6 \\
ary Two's
\end{tabular} & \[
\begin{gathered}
+\mathrm{V}_{\mathrm{DD}}+0.3 \\
+0.8 \\
0.4
\end{gathered}
\] & \[
\begin{aligned}
& \mathrm{V} \\
& \mathrm{~V} \\
& \mathrm{~V} \\
& \mathrm{~V} \\
& \mathrm{~V}
\end{aligned}
\] \\
\hline \begin{tabular}{l}
POWER-SUPPLY REQUIREMENTS \\
Operation \\
Quiescent Current \\
Operating Power \\
Power-Down Current
\end{tabular} & \(V_{D D}=+5 \mathrm{VDC}\) & +4.75 & \[
\begin{gathered}
+5 \\
8 \\
40 \\
1
\end{gathered}
\] & \[
\begin{gathered}
+5.25 \\
10 \\
50 \\
10
\end{gathered}
\] & \[
\begin{gathered}
\mathrm{VDC} \\
\mathrm{~mA} \\
\mathrm{~mW} \\
\mu \mathrm{~A}
\end{gathered}
\] \\
\hline \begin{tabular}{l}
TEMPERATURE RANGE \\
Operating \\
Storage
\end{tabular} & & \[
\begin{aligned}
& -40 \\
& -60
\end{aligned}
\] & & \[
\begin{gathered}
+85 \\
+100
\end{gathered}
\] & \[
\begin{aligned}
& { }^{\circ} \mathrm{C} \\
& { }^{\circ} \mathrm{C}
\end{aligned}
\] \\
\hline
\end{tabular}

NOTES: (1) Applies to full-differential signals. (2) The common-mode rejection test is performed with a 100 mV differential input.

PIN CONFIGURATION


ABSOLUTE MAXIMUM RATINGS
\begin{tabular}{|c|}
\hline \multirow[t]{7}{*}{Analog Input: Current .............................................. \begin{tabular}{r}
\(\pm 100 \mathrm{~mA}\), Momentary \\
\(\pm 10 \mathrm{~mA}\), Continuous
\end{tabular}
Voltage ................................... GND -0.3 V to \(\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}\)} \\
\hline \\
\hline \\
\hline \\
\hline \\
\hline \\
\hline \\
\hline
\end{tabular}

PIN DESCRIPTIONS
\begin{tabular}{|c|c|c|}
\hline PIN & NAME & PIN DESCRIPTION \\
\hline 1 & \(+\mathrm{V}_{\text {IN }}\) & Analog Input: Positive Input of the Differential Analog Input. \\
\hline 2 & \(-\mathrm{V}_{\text {IN }}\) & Analog Input: Negative Input of the Differential Analog Input. \\
\hline 3 & + \(\mathrm{V}_{\mathrm{DD}}\) & Input: Power Supply Voltage, +5V. \\
\hline 4 & CLK & Digital Input: Device System Clock. The system clock is in the form of a CMOScompatible clock. This is a Schmitt-Trigger input. \\
\hline 5 & DOUT/ \(\overline{\text { DRDY }}\) & Digital Output: Serial Data Output/Data Ready. A logic LOW on this output indicates that a new output word is available from the ADS1252 data output register. The serial data is clocked out of the serial data output shift register using SCLK. \\
\hline 6 & SCLK & Digital Input: Serial Clock. The serial clock is in the form of a CMOS-compatible clock. The serial clock operates independently from the system clock, therefore, it is possible to run SCLK at a higher frequency than CLK. The normal state of SCLK is LOW. Holding SCLK HIGH will either initiate a modulator reset for synchronizing multiple converters or enter power-down mode. This is a Schmitt-Trigger input. \\
\hline 7 & GND & Input: Ground. \\
\hline 8 & \(V_{\text {REF }}\) & Analog Input: Reference Voltage Input. \\
\hline
\end{tabular}

\section*{ELECTROSTATIC QN DISCHARGE SENSITIVITY}

This integrated circuit can be damaged by ESD. Burr-Brown recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

Electrostatic discharge can cause damage ranging from performance degradation to complete device failure. BurrBrown Corporation recommends that all integrated circuits be handled and stored using appropriate ESD protection methods.

PACKAGE/ORDERING INFORMATION
\begin{tabular}{|c|c|c|c|c|c|c|}
\hline PRODUCT & PACKAGE & PACKAGE DRAWING NUMBER & SPECIFIED
TEMPERATURE
RANGE & PACKAGE MARKING & ORDERING NUMBER \({ }^{(1)}\) & TRANSPORT MEDIA \\
\hline \begin{tabular}{l}
ADS1252U \\
"
\end{tabular} & \[
\begin{gathered}
\text { SO-8 } \\
"
\end{gathered}
\] & \[
\begin{gathered}
182 \\
"
\end{gathered}
\] & \[
\begin{gathered}
-40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \\
\hline
\end{gathered}
\] & \begin{tabular}{l}
ADS1252U \\
"
\end{tabular} & \[
\begin{gathered}
\text { ADS1252U } \\
\text { ADS1252U/2K5 }
\end{gathered}
\] & \begin{tabular}{l}
Rails \\
Tape and Reel
\end{tabular} \\
\hline
\end{tabular}

NOTE: (1) Models with a slash (/) are available only in Tape and Reel in the quantities indicated (e.g., 2 K 5 indicates 2500 devices per reel). Ordering 2500 pieces of "ADS1252U/2K5" will get a single 2500-piece Tape and Reel.

\section*{TYPICAL PERFORMANCE CURVES}

At \(T_{A}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V}, C L K=16 \mathrm{MHz}\), and \(\mathrm{V}_{\text {REF }}=4.096\), unless otherwise specified.







\section*{TYPICAL PERFORMANCE CURVES (Cont.)}

At \(T_{A}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V}, \mathrm{CLK}=16 \mathrm{MHz}\), and \(\mathrm{V}_{\text {REF }}=4.096\), unless otherwise specified.






\section*{TYPICAL PERFORMANCE CURVES (Cont.)}

At \(T_{A}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V}, C L K=16 \mathrm{MHz}\), and \(\mathrm{V}_{\text {REF }}=4.096\), unless otherwise specified.






\section*{THEORY OF OPERATION}

The ADS1252 is a precision, high-dynamic range, 24-bit, delta-sigma, A/D converter capable of achieving very high-resolution digital results at high data rates. The analog-input signal is sampled at a rate determined by the frequency of the system clock (CLK). The sampled analog input is modulated by the delta-sigma A/D modulator, which is followed by a digital filter. A sinc \({ }^{5}\) digital low-pass filter processes the output of the delta-sigma modulator and writes the result into the data-output register. The DOUT/DRDY pin is pulled LOW, indicating that new data is available to be read by the external microcontroller/microprocessor. As shown in the block diagram, the main functional blocks of the ADS1252 are the fourth-order delta-sigma modulator, a digital filter, control logic, and a serial interface. Each of these functional blocks is described below.

\section*{ANALOG INPUT}

The ADS1252 contains a fully differential analog input. In order to provide low system noise, common-mode rejection of 100 dB and excellent power-supply rejection, the design topology is based on a fully differential switched-capacitor architecture. The bipolar input voltage range is from -4.096 to +4.096 V , when the reference input voltage equals +4.096 V . The bipolar range is with respect to \(-\mathrm{V}_{\mathrm{IN}}\), and not with respect to GND.
Figure 1 shows the basic input structure of the ADS1252. The impedance is directly related to the sampling frequency of the input capacitor which is set by the CLK rate. Higher CLK rates result in lower impedance, and lower CLK rates result in higher impedance.


FIGURE 1. Analog-Input Structure.
The input impedance of the analog input changes with ADS1252 system clock frequency (CLK). The relationship is:
\[
\mathrm{A}_{\mathrm{IN}} \text { Impedance }(\Omega)=(16 \mathrm{MHz} / \mathrm{CLK}) \cdot 19,000
\]

With regard to the analog-input signal, the overall analog performance of the device is affected by three items: first, the input impedance can affect accuracy. If the source impedance of the input signal is significant, or if there is passive filtering prior to the ADS1252, a significant portion of the signal can be lost across this external impedance. The magnitude of the effect is dependent on the desired system performance.
Second, the current into or out of the analog inputs must be limited. Under no conditions should the current into or out of the analog inputs exceed 10 mA .
Third, to prevent aliasing of the input signal, the bandwidth of the analog-input signal must be band limited; the bandwidth is a function of the system clock frequency. With a system clock frequency of 16 MHz , the data-output rate is 41.667 kHz with a -3 dB frequency of 9 kHz . The -3 dB frequency scales with the system clock frequency.
To guarantee the best linearity of the ADS1252, a fully differential signal is recommended.

\section*{BIPOLAR INPUT}

The differential inputs of the ADS1252 were designed to accept differential inputs. However, each analog input voltage must stay between -0.3 V and \(\mathrm{V}_{\mathrm{DD}}\). With a reference voltage at less than half of \(\mathrm{V}_{\mathrm{DD}}\), one input can be tied to the reference voltage, and the other input can range from 0 to \(2 \cdot\) VREF. By using a single op amp circuit featuring a single amplifier and four external resistors, the ADS1252 can be configured to accept bipolar inputs referenced to ground. The conventional \(\pm 2.5 \mathrm{~V}, \pm 5 \mathrm{~V}\), and \(\pm 10 \mathrm{~V}\) input ranges can be interfaced to the ADS1252 using the resistor values shown in Figure 2.


FIGURE 2. Level Shift Circuit for Bipolar Input Ranges.

\section*{DELTA-SIGMA MODULATOR}

The ADS1252 operates from a nominal system clock frequency of 16 MHz . The modulator frequency is fixed in relation to the system clock frequency. The system clock frequency is divided by 6 to derive the modulator frequency. Therefore, with a system clock frequency of 16 MHz , the modulator frequency is 2.667 MHz . Furthermore, the oversampling ratio of the modulator is fixed in relation to the modulator frequency. The oversampling ratio of the modulator is 64 , and with the modulator frequency running at 2.667 MHz , the data rate is 41.667 kHz . Using a slower system clock frequency will result in a lower data output rate, as shown in Table I.
\begin{tabular}{|c|c|}
\hline CLK (MHz) & DATA OUTPUT RATE (Hz) \\
\hline \(16.000^{(1)}\) & 41,667 \\
\(15.360^{(1)}\) & 40,000 \\
\(15.000^{(1)}\) & 30,063 \\
\(14.745600^{(1)}\) & 38,400 \\
\(14.318180^{(1)}\) & 37,287 \\
\(12.288000^{(1)}\) & 32,000 \\
\(12.000000^{(1)}\) & 31,250 \\
\(11.059220^{(1)}\) & 28,800 \\
\(10.000000^{(1)}\) & 26,042 \\
9.600000 & 25,000 \\
\(7.372800^{(1)}\) & 19,200 \\
\(6.144000^{(1)}\) & 16,000 \\
\(6.000000^{(1)}\) & 15,625 \\
\(4.915200^{(1)}\) & 12,800 \\
\(3.686400^{(1)}\) & 9,600 \\
\(3.072000^{(1)}\) & 8,000 \\
\(2.457600^{(1)}\) & 6,400 \\
\(1.843200^{(1)}\) & 4,800 \\
0.921600 & 2,400 \\
0.460800 & 1,200 \\
0.384000 & 1,000 \\
0.192000 & 500 \\
0.038400 & 100 \\
0.023040 & 60 \\
0.019200 & 50 \\
0.011520 & 30 \\
0.009600 & 25 \\
0.007680 & 20 \\
0.006400 & 16.67 \\
0.005760 & 15 \\
0.004800 & 10.50 \\
0.003840 & \\
NOTE: (1) Standard Clock Oscillator. & \\
\hline
\end{tabular}

TABLE I. CLK Rate versus Data Output Rate.
(
FIGURE 3. Recommended External Voltage Reference Circuit for Best Low-Noise Operation with the ADS1252.
frequency should be 19.200 kHz , this will set the data-output rate to 50 Hz (see Table I and Figure 5). For 60 Hz rejection, the system CLK frequency should be 20.040 kHz , this will set the data-output rate to 60 Hz (see Table I and Figure 6). If both 50 Hz and 60 Hz rejection is required, then the system CLK should be 3.840 kHz ; this will set the data-output rate to 10 Hz and reject both 50 Hz and 60 Hz (See Table I and Figure 7).

There is an additional benefit in using a lower data-output rate. It provides better rejection of signals in the frequency band of interest. For example, with a 50 Hz data-output rate, a significant signal at 75 Hz may alias back into the passband at 25 Hz . This is due to the fact that rejection at 75 Hz may only be 66 dB in the stopband-frequencies higher than the first-notch frequency (see Figure 5). However, setting the data-output rate to 10 Hz will provide 135 dB rejection at 75 Hz (see Figure 7). A similar benefit is gained at frequencies near the data-output rate (see Figures 8, 9, 10, and 11). For example, with a 50 Hz data-output rate, rejection at 55 Hz may only be 105 dB (see Figure 8). However, with a 10 Hz data-output rate, rejection at 55 Hz will be 122 dB (see Figure 9). If a slower data-output rate does not meet the system requirements, then the analog front end can be designed to provide the needed attenuation to prevent aliasing. Additionally, the data-output rate may be increased and additional digital filtering may be done in the processor or controller.

The digital filter is described by the following transfer function:
\[
\begin{gathered}
|H(f)|=\left|\frac{\sin \left(\frac{\pi \cdot f \cdot 64}{f_{\mathrm{MOD}}}\right)}{64 \cdot \sin \left(\frac{\pi \cdot \mathrm{f}}{\mathrm{f}_{\mathrm{MOD}}}\right)}\right|^{5} \\
\text { or } \\
\mathrm{H}(\mathrm{z})=\left(\frac{1-\mathrm{z}^{-64}}{64 \cdot\left(1-\mathrm{z}^{-1}\right)}\right)^{5}
\end{gathered}
\]

The digital filter requires five conversions to fully settle. The modulator has an oversampling ratio of 64, therefore, it requires \(5 \cdot 64\), or 320 modulator results, or clocks, to fully settle. Since the modulator clock is derived from the system clock (CLK) (modulator clock \(=\mathrm{CLK} \div 6\) ), the number of system clocks required for the digital filter to fully settle is \(5 \cdot 64 \cdot 6\), or 1920 CLKs. This means that any significant step change at the analog input requires five full conversions to settle. However, if the analog input change occurs asynchronously to the DOUT/ \(\overline{\text { DRDY }}\) pulse, six conversions are required to ensure full settling.

\section*{CONTROL LOGIC}

The control logic is used for communications and control of the ADS1252.

\section*{Power-Up Sequence}

Prior to power-up, all digital and analog-input pins must be LOW. At the time of power-up, these signal inputs can be biased to a voltage other than 0 V , however, they should never exceed \(+\mathrm{V}_{\mathrm{DD}}\).
Once the ADS1252 powers up, the DOUT/DRDY line will pulse LOW on the first conversion. This data will not be valid. The sixth pulse of DOUT/DRDY will be valid data from the analog input signal.

\section*{DOUT/DRDY}

The DOUT/DRDY output signal alternates between two modes of operation. The first mode of operation is the Data Ready mode ( \(\overline{\mathrm{DRDY}}\) ) to indicate that new data has been loaded into the data-output register and is ready to be read. The second mode of operation is the Data Output (DOUT) mode and is used to serially shift data out of the Data Output Register (DOR). See Figure 12 for the time domain partitioning of the DRDY and DOUT function.
See Figure 13 for the basic timing of DOUT/DRDY. During the time defined by \(t_{2}, t_{3}\), and \(t_{4}\), the DOUT/DRDY pin functions in DRDY mode. The state of the DOUT/DRDY pin would be HIGH prior to the internal transfer of new data to the DOR. The result of the A/D


FIGURE 4. Normalized Digital Filter Response.


FIGURE 6. Digital Filter Response (60Hz).


FIGURE 8. Expanded Digital Filter Response ( 50 Hz with a 50 Hz Notch).


FIGURE 5. Digital Filter Response (50Hz).


FIGURE 7. Digital Filter Response (10Hz Multiples).


FIGURE 9. Expanded Digital Filter Response ( 50 Hz with a 10Hz Notch).


FIGURE 10. Expanded Digital Filter Response (60Hz with a 60 Hz Notch).
conversion would be written to the DOR from MSB to LSB in the time defined by \(\mathrm{t}_{1}\) (see Figures 12 and 13). The DOUT/DRDY line would then pulse LOW for the time defined by \(\mathrm{t}_{2}\), and then pulse HIGH for the time defined by \(\mathrm{t}_{3}\) to indicate that new data was available to be read. At this point, the function of the DOUT/DRDY pin would change to DOUT mode. Data would be shifted out on the pin after \(\mathrm{t}_{7}\). The device communicating with the ADS1252 can provide SCLKs to the ADS1252 after the time defined by \(\mathrm{t}_{6}\). The normal mode of reading data from the ADS1252 would be for the device reading the ADS1252 to latch the data on the rising edge of SCLK (since data is shifted out of the ADS1252 on the falling edge of SCLK). In order to retrieve valid data, the entire DOR must be read before the DOUT/DRDY pin reverts back to \(\overline{\text { DRDY }}\) mode.
If SCLKs were not provided to the ADS1252 during the DOUT mode, the MSB of the DOR would be present on the DOUT/DRDY line until the time defined by \(\mathrm{t}_{4}\). If an incomplete read of the ADS1252 took place while in DOUT mode (i.e., less than 24 SCLKs were provided), the state of the last bit read would be present on the DOUT/DRDY line until the time defined by \(\mathrm{t}_{4}\). If more than 24 SCLKs were provided during DOUT mode, the DOUT/DRDY line would stay LOW until the time defined by \(\mathrm{t}_{4}\).


FIGURE 11. Expanded Digital Filter Response ( 60 Hz with a 10 Hz Notch).

The internal data pointer for shifting data out on DOUT/DRDY is reset on the falling edge of the time defined by \(t_{1}\) and \(t_{4}\). This ensures that the first bit of data shifted out of the ADS1252 after \(\overline{\text { DRDY }}\) mode is always the MSB of new data.

\section*{SYNCHRONIZING MULTIPLE CONVERTERS}

The normal state of SCLK is LOW, however, by holding SCLK HIGH, multiple ADS1252s can be synchronized. This is accomplished by holding SCLK HIGH for at least four, but less than twenty, consecutive DOUT/ \(\overline{\text { DRDY }}\) cycles (see Figure 14). After the ADS1252 circuitry detects that SCLK has been held HIGH for four consecutive DOUT/DRDY cycles, the DOUT/DRDY pin will pulse LOW for 3 CLK cycles and then be held HIGH, and the modulator will be held in a reset state. The modulator will be released from reset and synchronization will occur on the falling edge of SCLK. It is important to note that prior to synchronization, the DOUT/DRDY pulse of multiple ADS1252s in the system could have a difference in timing up to one \(\overline{\text { DRDY }}\) period. Therefore to ensure synchronization, the SCLK should be held HIGH for at least five \(\overline{\mathrm{DRDY}}\) cycles. The first DOUT/ \(\overline{\text { DRDY }}\) pulse after the falling edge of SCLK will occur at \(\mathrm{t}_{14}\). Valid data will not be present until the sixth DOUT/DRDY pulse.

\section*{POWER-DOWN MODE}

The normal state of SCLK is LOW, however, by holding SCLK HIGH, the ADS1252 will enter power-down mode. This is accomplished by holding SCLK HIGH for at least twenty consecutive DOUT/DRDY periods (see Figure 15). After the ADS1252 circuitry detects that SCLK has been held HIGH for four consecutive DOUT/DRDY cycles, the DOUT/DRDY pin will pulse LOW for 3 CLK cycles and then be held HIGH, and the modulator will be held in a reset state. If SCLK is held HIGH for an additional sixteen DOUT/DRDY periods, the ADS 1252 will enter power-down mode. The part will be released from powerdown mode on the falling edge of SCLK. It is important to note that the DOUT/DRDY pin will be held HIGH after four DOUT/ \(\overline{\mathrm{DRDY}}\) cycles, but power-down mode will not be entered for an additional sixteen DOUT/ \(\overline{\mathrm{DRDY}}\) periods. The first DOUT/ \(\overline{\text { DRDY }}\) pulse after the falling edge of SCLK will occur at \(\mathrm{t}_{16}\). Subsequent DOUT/DRDY pulses will occur normally. Valid data will not be present until the sixth DOUT/DRDY pulse.

\section*{SERIAL INTERFACE}

The ADS1252 includes a simple serial interface which can be connected to microcontrollers and digital signal processors in a variety of ways. Communications with the ADS1252 can commence on the first detection of the DOUT/ \(\overline{\mathrm{DRDY}}\) pulse after power up, although data will not be valid until the sixth conversion.
It is important to note that the data from the ADS 1252 is a 24-bit result transmitted MSB-first in Offset Two's Complement format, as shown in Table III.
\begin{tabular}{|c|c|}
\hline DIFFERENTIAL VOLTAGE INPUT & DIGITAL OUTPUT (HEX) \\
\hline +Fulll Scale & 7 FFFFFH \\
Zero & 000000 H \\
-Full Scale & 800000 H \\
\hline
\end{tabular}

TABLE III. ADS1252 Data Format (Offset Two's Complement).
\begin{tabular}{|c|c|c|c|c|c|}
\hline SYMBOL & DESCRIPTION & MIN & TYP & MAX & UNITS \\
\hline \(t_{\text {DRDY }}\) & Conversion Cycle & & 384 •CLK & & ns \\
\hline DRDY Mode & \(\overline{\text { DRDY Mode }}\) & & \(36 \cdot\) CLK & & ns \\
\hline DOUT Mode & DOUT Mode & & \(348 \cdot\) CLK & & ns \\
\hline \(\mathrm{t}_{1}\) & DOR Write Time & & \(6 \cdot\) CLK & & ns \\
\hline \(\mathrm{t}_{2}\) & DOUT/ \(\overline{\text { DRDY }}\) LOW Time & & \(6 \cdot\) CLK & & ns \\
\hline \(\mathrm{t}_{3}\) & DOUT/DRDY HIGH Time (Prior to Data Out) & & \(6 \cdot \mathrm{CLK}\) & & ns \\
\hline \(\mathrm{t}_{4}\) & DOUT/DRDY HIGH Time (Prior to Data Ready) & & \(24 \cdot\) CLK & & ns \\
\hline \(t_{5}\) & Rising Edge of CLK to Falling Edge of DOUT/(1) & & & 30 & ns \\
\hline \(t_{6}\) & End of DRDY Mode to Rising Edge of First SCLK & 30 & & & ns \\
\hline \(\mathrm{t}_{7}\) & End of DRDY Mode to Data Valid (Propogation Delay) & & & 30 & ns \\
\hline \(\mathrm{t}_{8}\) & Falling Edge of SCLK to Data Valid (Hold Time) & 5 & & & ns \\
\hline \(\mathrm{t}_{9}\) & Falling Edge of SCLK to Next Data Out Valid (Propogation Delay) & & & 30 & ns \\
\hline \(\mathrm{t}_{10}\) & SCLK Setup Time for Synchronization or Power Down & 30 & & & ns \\
\hline \(t_{11}\) & DOUT//DRDY Pulse for Synchronization or Power Down & & \(3 \cdot\) CLK & & ns \\
\hline \(\mathrm{t}_{12}\) & Rising Edge of SCLK Until Start of Synchronization & \(1537 \cdot\) CLK & & 7679 • CLK & ns \\
\hline \(\mathrm{t}_{13}\) & Synchronization Time & \(0.5 \cdot\) CLK & & 6143.5 • CLK & ns \\
\hline \(\mathrm{t}_{14}\) & Falling Edge of CLK (After SCLK Goes Low) Until Start of DRDY Mode & & \(314.5 \cdot\) CLK & & ns \\
\hline \(\mathrm{t}_{15}\) & Rising Edge of SCLK Until Start of Power Down & 7681 •CLK & & & ns \\
\hline \(\mathrm{t}_{16}\) & Falling Edge of CLK (After SCLK Goes Low) Until Start of \(\overline{\text { DRDY }}\) Mode & 591.5 - CLK & & 592.5 •CLK & ns \\
\hline \(\mathrm{t}_{17}\) & Falling Edge of Last DOUT/ \(\overline{\text { DRDY }}\) to Start of Power Down & & \(6143.5 \cdot\) CLK & & ns \\
\hline
\end{tabular}

TABLE II. Digital Timing.


FIGURE 12. DOUT/ \(\overline{\text { DRDY }}\) Partitioning.
CLK
FIGURE 13. DOUT/ \(\overline{\mathrm{DRDY}}\) Timing.

FIGURE 14. Synchronization Mode.

The data must be clocked out before the ADS1252 enters \(\overline{\text { DRDY }}\) mode to ensure reception of valid data, as described in the DOUT/DRDY section of this data sheet.

\section*{ISOLATION}

The serial interface of the ADS1252 provides for simple isolation methods. The CLK signal can be local to the ADS1252, which then only requires two signals (SCLK, and DOUT/(DRDY) to be used for isolated data acquisition.

\section*{LAYOUT}

\section*{POWER SUPPLY}

The power supply should be well regulated and low noise. For designs requiring very high resolution from the ADS1252, power-supply rejection will be a concern. Avoid running digital lines under the device as they may couple noise onto the die. High-frequency noise can capacitively couple into the analog portion of the device and will alias back into the passband of the digital filter, affecting the conversion result.

\section*{GROUNDING}

The analog and digital sections of the system design should be carefully and cleanly partitioned. Each section should have its own ground plane with no overlap between them. GND should be connected to the analog ground plane, as well as all other analog grounds. Do not join the analog and digital ground planes on the board, but instead connect the two with a moderate signal trace. For multiple converters, connect the two ground planes at one location as central to all of the converters as possible. In some cases, experimentation may be required to find the best point to connect the two planes together. The printed circuit board can be designed to provide different analog/digital ground connections via short jumpers. The initial prototype can be used to establish which connection works best.

\section*{DECOUPLING}

Good decoupling practices should be used for the ADS1252 and for all components in the design. All decoupling capacitors, and specifically the \(0.1 \mu \mathrm{~F}\) ceramic capacitors, should be placed as close as possible to the pin being decoupled. A \(1 \mu \mathrm{~F}\) to \(10 \mu \mathrm{~F}\) capacitor, in parallel with a \(0.1 \mu \mathrm{~F}\) ceramic capacitor, should be used to decouple \(\mathrm{V}_{\mathrm{DD}}\) to GND.

\section*{SYSTEM CONSIDERATIONS}

The recommendations for power supplies and grounding will change depending on the requirements and specific design of the overall system. Achieving 24 bits of noise performance is a great deal more difficult than achieving 12 bits of noise performance. In general, a system can be broken up into four different stages:
- Analog Processing
- Analog Portion of the ADS1252
- Digital Portion of the ADS1252
- Digital Processing

For the simplest system consisting of minimal analog signal processing (basic filtering and Gain), a microcontroller, and one clock source, one can achieve high resolution by powering all components by a common power supply. In addition, all components could share a common ground plane. Thus, there would be no distinctions between "analog" power and ground, and "digital" power and ground. The layout should still include a power plane, a ground plane, and careful decoupling. In a more extreme case, the design could include:
- Multiple ADS1252s
- Extensive Analog Signal Processing
- One or More Microcontrollers, Digital Signal Processors, or Microprocessors
- Many Different Clock Sources
- Interconnections to Various Other Systems

High resolution will be very difficult to achieve for this design. The approach would be to break the system into as many different parts as possible. For example, each ADS1252 may have its own "analog" processing front end.

\section*{DEFINITION OF TERMS}

An attempt has been made to be consistent with the terminology used in this data sheet. In that regard, the definition of each term is given as follows:
Analog-Input Differential Voltage-for an analog signal that is fully differential, the voltage range can be compared to that of an instrumentation amplifier. For example, if both analog inputs of the ADS1252 are at 2.048 V , the differential voltage is 0 V . If one analog input is at 0 V and the other analog input is at 4.096 V , then the differential voltage magnitude is 4.096 V . This is the case regardless of which
input is at 0 V and which is at 4.096 V . The digital-output result, however, is quite different. The analog-input differential voltage is given by the following equation:
\[
+\mathrm{V}_{\mathrm{IN}}-\left(-\mathrm{V}_{\mathrm{IN}}\right)
\]

A positive digital output is produced whenever the analog-input differential voltage is positive, while a negative digital output is produced whenever the differential is negative. For example, a positive full-scale output is produced when the converter is configured with a 4.096 V reference, and the analog-input differential is 4.096 V . The negative full-scale output is produced when the differential voltage is -4.096 V . In each case, the actual input voltages must remain within the -0.3 V to \(+\mathrm{V}_{\mathrm{DD}}\) range.

Actual Analog-Input Voltage-the voltage at any one analog input relative to GND.
Full-Scale Range (FSR)—as with most ADCs, the fullscale range of the ADS1252 is defined as the "input" which produces the positive full-scale digital output minus the "input" which produces the negative full-scale digital output. For example, when the converter is configured with a 4.096 V reference, the differential full-scale range is:
[4.096V (positive full scale) \(-(-4.096 \mathrm{~V})\) (negative full scale) \(]=8.192 \mathrm{~V}\)
Least Significant Bit (LSB) Weight-this is the theoretical amount of voltage that the differential voltage at the analog input would have to change in order to observe a change in the output data of one least significant bit. It is computed as follows:
\[
\text { LSB Weight }=\frac{\text { Full-Scale Range }}{2^{\mathrm{N}}}
\]
where N is the number of bits in the digital output.
Conversion Cycle-as used here, a conversion cycle refers to the time period between DOUT/DRDY pulses.

Effective Resolution (ER)—of the ADS1252 in a particular configuration can be expressed in two different units: bits rms (referenced to output) and \(\mu \mathrm{Vrms}\) (referenced to input). Computed directly from the converter's output data,
each is a statistical calculation based on a given number of results. Noise occurs randomly; the rms value represents a statistical measure which is one standard deviation. The ER in bits can be computed as follows:
\[
\text { ER in bits rms }=\frac{20 \bullet \log \left(\frac{2 \bullet \mathrm{~V}_{\mathrm{REF}}}{\text { Vrms noise }}\right)}{6.02}
\]

The \(2 \cdot \mathrm{~V}_{\text {REF }}\) figure in each calculation represents the full-scale range of the ADS1252. This means that both units are absolute expressions of resolution-the performance in different configurations can be directly compared, regardless of the units.
Noise Reduction-for random noise, the ER can be improved with averaging. The result is the reduction in noise by the factor \(\sqrt{\mathrm{N}}\), where N is the number of averages, as shown in Table IV. This can be used to achieve true 24-bit performance at a lower data rate. To achieve 24 bits of resolution, more than 24 bits must be accumulated. A 36-bit accumulator is required to achieve an ER of 24 bits. The following uses \(\mathrm{V}_{\mathrm{REF}}=4.096 \mathrm{~V}\), with the ADS1252 outputting data at 40 kHz , a 4096 point average will take 102.4 ms . The benefits of averaging will be degraded if the input signal drifts during that 100 ms .
\begin{tabular}{|c|c|c|c|}
\hline \begin{tabular}{c} 
N \\
(NUMBER \\
OF AVERAGES)
\end{tabular} & \begin{tabular}{c} 
NOISE \\
REDUCTION \\
FACTOR
\end{tabular} & \begin{tabular}{c} 
ER \\
IN \\
VRMS
\end{tabular} & \begin{tabular}{c} 
ER \\
IN \\
BITS RMS
\end{tabular} \\
\hline 1 & 1 & \(31.3 \mu \mathrm{~V}\) & 18 \\
2 & 1.414 & \(22.1 \mu \mathrm{~V}\) & 18.5 \\
4 & 2 & \(15.6 \mu \mathrm{~V}\) & 19 \\
8 & 2.82 & \(11.1 \mu \mathrm{~V}\) & 19.5 \\
16 & 4 & \(7.82 \mu \mathrm{~V}\) & 20 \\
32 & 5.66 & \(5.53 \mu \mathrm{~V}\) & 20.5 \\
64 & 8 & \(3.91 \mu \mathrm{~V}\) & 21 \\
128 & 11.3 & \(2.77 \mu \mathrm{~V}\) & 21.5 \\
256 & 16 & \(1.96 \mu \mathrm{~V}\) & 22 \\
512 & 22.6 & \(1.38 \mu \mathrm{~V}\) & 22.5 \\
1024 & 32 & 978 nV & 23 \\
2048 & 45.25 & 692 nV & 23.5 \\
4096 & 64 & 489 nV & 24 \\
\hline
\end{tabular}

TABLE IV. Averaging.

\section*{PACKAGING INFORMATION}
\begin{tabular}{|cccccc|}
\hline ORDERABLE DEVICE & STATUS(1) & PACKAGE TYPE & PACKAGE DRAWING & PINS & PACKAGE QTY \\
\hline ADS1252U & ACTIVE & SOIC & D & 8 & 100 \\
\hline ADS1252U/2K5 & ACTIVE & SOIC & D & 8 & 2500 \\
\hline
\end{tabular}
(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but Tl does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
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